1 Startup

The photo below shows the output voltage startup waveform after the application of 6.5V in. The 10V output was loaded to 0A. (Vin is 5V/DIV, Vout is 2V/DIV, 10mS/DIV)

The photo below shows the output voltage startup waveform after the application of 6.5V in. The 10V output was loaded to 2A. (Vin is 5V/DIV, Vout is 2V/DIV, 10mS/DIV)
The photo below shows the output voltage startup waveform after the application of 16V in. The 10V output was loaded to 0A. (Vin is 5V/DIV, Vout is 2V/DIV, 10mS/DIV)

The photo below shows the output voltage startup waveform after the application of 16V in. The 10V output was loaded to 2A. (Vin is 5V/DIV, Vout is 2V/DIV, 10mS/DIV)
2 Efficiency

The converter efficiency is shown below for Vin = 12V and Vout = 10V.

The converter efficiency is shown below for Vin = 16V and Vout = 10V.
The converter efficiency is shown below for $V_{in} = 6.5\text{V}$ and $V_{out} = 10\text{V}$.

![10V SEPIC Converter Efficiency, Vin = 6.5V](chart.png)
3 Output Ripple Voltage

The 10V output ripple voltage (AC coupled) is shown in the figure below. The image was taken with the output loaded to 2A. The input voltage is set to 6.5V. (50mV/DIV, 1μS/DIV)

The 10V output ripple voltage (AC coupled) is shown in the figure below. The image was taken with the output loaded to 2A. The input voltage is set to 16V. (50mV/DIV, 1μS/DIV)
4 Load Transients

The photo below shows the 10V output voltage (ac coupled) when the load current is stepped between 1A and 2A. Vin = 12V. (500mV/DIV, 1A/DIV, 200uS/DIV)

The photo below shows the 10V output voltage (ac coupled) when the load current is stepped between 0.5A and 2A. Vin = 12V. (500mV/DIV, 1A/DIV, 200uS/DIV)
The photo below shows the 10V output voltage (ac coupled) when the load current is stepped between 0.25A and 2A. Vin = 12V.  

(500mV/DIV, 1A/DIV, 200uS/DIV)

The photo below shows the 10V output voltage (ac coupled) when the load current is stepped between 0A and 2A. Vin = 12V.  

(1V/DIV, 1A/DIV, 200uS/DIV)
5 Switch Node Waveforms

The photo below shows the FET switching voltage for an input voltage of 6.5V and a 2A load. (5V/DIV, 500nS/DIV)

The photo below shows the FET switching voltage for an input voltage of 12V and a 2A load. (5V/DIV, 500nS/DIV)
The photo below shows the FET switching voltage for an input voltage of 16V and a 2A load. 

(5V/DIV, 500nS/DIV)

The photo below shows the FET switching voltage for an input voltage of 16V and a 0.45A load.
The converter is operating in DCM. 

(5V/DIV, 500nS/DIV)
6  Loop Gain

The plot below shows the loop gain with the input voltage set to 6.5V and 16V with the output set to 2A.

Loop Gain (Vin = 6.5V)  BW: 12.3KHz  PM: 60 degrees
Loop Gain (Vin = 16V)  BW: 16.6KHz  PM: 68 degrees

The plot below shows the loop gain with the input voltage set to 6.5V and 16V with the output set to 0.5A.

Loop Gain (Vin = 6.5V)  BW: 11.5KHz  PM: 73 degrees
Loop Gain (Vin = 16V)  BW: 3.36KHz  PM: 74 degrees
7  Photo

The photo below shows the PMP20193 REVC assy.
8 Thermal Image

A thermal image is shown below operating at 12V input and 10V@2A output (room temp, no airflow).
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